List of Abbreviations

ABS acrylonitrile butadiene styrene

ABS arc bond sputtering

AEM analytical electron microscopy
AES Auger electron spectroscopy
AFM atomic force microscopy
ALD atomic layer deposition

APGD atmospheric pressure glow discharge

APT atom-probe tomography

AR angle-resolved AR antireflective

ARE activated reactive evaporation

ARXPS angle resolved X-ray photoelectron spectroscopy

ASF atomic sensitivity factor
ASH atomic scale heating
ATR attenuated total reflection

BARE biased activated reactive evaporation

BE binding energy BF bright field

CARS coherent anti-Stokes Raman scattering

CCD charge-coupled device CCP capacitively coupled plasma CDC carbide-derived carbon

Ch chalcogen

CIGS copper indium gallium diselenide

CIP chemical ion plating
CIS copper indium diselenide

CMA coaxial cylindrical mirror analyzer

C:Me metal-containing carbon
COF coefficient of friction
CQ collisional quenching
CSD charge state distribution

CTEM conventional transmission electron microscopy

CVD chemical vapor deposition
DBD dielectric barrier discharge

DC-MS direct-current magnetron sputtering

DF dark field

DFT density functional theory dHB duMond–Hart–Bartels

DIET desorption induced by electronic transitions

DLC diamond-like carbon

DRAM dynamic random access memory DRS direct recoiling spectroscopy

DRV dimer row vacancy

DVD directed vapor deposition

DVL dimer vacancy line EAG Evans Analytical Group

EB electron beam

EBSD electron backscattering diffraction

EC electrochromic

ECR electron cyclotron resonance

ED electron diffraction

EDTA ethylene diamine tetraacetic acid
EDXS energy-dispersive X-ray spectroscopy
EEDF electron energy distribution function
EELS electron energy-loss spectroscopy

EIS electrochemical impedance spectroscopy

ELNES energy loss near-edge structure ELO epitaxial lateral overgrowth

EM effective medium

EMA effective medium approximation

EMSL Environmental Molecular Sciences Laboratory

ER erosion resistance

ERDA elastic recoil detection analysis

ERD-TOF elastic recoil detection in the time-of-flight regime

ESCA electron spectroscopy for chemical analysis

ESD electron-stimulated desorption
ESZM extended structure zone model
ETFE ethylene-tetrafluoroethylene
EXAFS X-ray absorption fine structure

EXELFS extended electron energy loss fine structure

FCA filtered cathodic arc

FCC Federal Communications Commission

FHC fused hollow cathode FIB focused ion beams

FTIR Fourier transform infra-red spectroscopy

GB grain boundary

GDMS glow discharge mass spectrometry

GLAD glancing angle (of incidence) deposition

giant magnetoresistance **GMR**

GRIN gradient-index

GRXRD glancing-incidence X-ray diffraction

HA hydroxyapatite

HAADF high-angle annular dark field HEIS high-energy ion scattering **HEMT** high electron mobility transistor

H-HEAD hybrid hollow electrode activated discharge **HIPIMS** high-power impulse magnetron sputtering

HMCTSZN hexamethyl cyclotrisilazane **HMDSN** hexamethyl disilazane **HMDSO** hexamethyl disiloxane

HPPMS high-power pulsed magnetron sputtering **HRPVD** high-rate physical vapor deposition

HRTEM high-resolution transmission electron microscopy

HRXRD high-resolution X-ray diffraction

IA ion assist

IAD ionization assisted deposition **IBAD** ion beam assisted deposition **IBED** ion beam enhanced deposition

IC integrated circuit IC internal conversion

ICP inductively coupled plasma

IEA ion energy analyzer

IEDF ion energy distribution function

IGC inert gas condensation **IMFP** inelastic mean free path **IPA** isopropyl alcohol

IPVD ionized physical vapor deposition

IR infrared

ISC intersystem crossing

ISE ion-induced secondary electron ISS ion scattering spectroscopy

ITO indium-tin oxide

ITUInternational Telecommunications Union

IVD ion vapor deposition JVD jet vapor deposition KE kinetic energy

KPZ Kardar-Parisi-Zhang

LAFAD large-area filtered arc deposition LAIGC laser-assisted inert gas condensation

LC liquid crystal

LEED low-energy electron diffraction
LEIS low-energy ion scattering
LEL lower explosive limit
LIF laser induced fluorescence

LML liquid multilayer

LPPD low-pressure plasma deposition

LSCF lanthanum strontium cobalt iron oxide

MBE molecular beam epitaxy MD molecular dynamics

MDP molecularly doped polymer
MEIS medium-energy ion scattering
MEMS microelectromechanical system

MF mid-frequency

MF/DMS mid-frequency/dual magnetron sputtering

MH Mullins-Herring
MIM metal-insulator-metal

ML monolayer

MLD molecular layer deposition MNS metal-nitride semiconductor

MOCVD metal-organic chemical vapor deposition MoDTC molybdenum dialkyl dithiocarbamate

MS magnetron sputtering MS mass spectrometry

MSRI mass spectroscopy of recoiled ions

MW microwave nc nanocomposite

NCD nanocrystalline diamond

NIR near infrared

NIST National Institute of Standards and Technology

NPL National Physical Laboratory NRA nuclear reaction analysis

NSOM near-field scanning optical microscopy

OCP open circuit potential

OES optical emission spectroscopy
OIF optical interference filter
OLED organic light-emitting device
OTR oxygen transmission rate

PACVD plasma-assisted chemical vapor deposition

PC polycarbonate PC photonic crystal pc-D polycrystalline diamond

PECVD plasma-enhanced chemical vapor deposition

PET polyethylene terephthalate

PICVD plasma impulse chemical vapor deposition PIIID plasma immersion ion implantation deposition

proton-induced X-ray emission PIXE

PLD pulsed laser deposition

PLZT lead lanthanum zirconate titanate

PMI. polymer multilayer **PMMA** polymethyl methacrylate **PMS** plasma mass spectrometry

PPFC plasma polymerized fluorocarbon **PPHC** plasma polymerized hydrocarbon **PPML** plasma polymer multilayer process **PPOS** plasma polymerized organosilicone

PTFE polytetrafluoroethylene **PVD** physical vapor deposition **PZT** lead-zirconium-titanate

QA QuinAcridone OD quantum dot

RBS Rutherford backscattering spectrometry

RF radio frequency

RHEED reflection high-energy electron diffraction

RIE reactive ion etching RIP reactive ion plating

RMS Roughness Measurement System

RPE reactive plasma etching RS Raman spectroscopy RT room temperature

RTSE real-time spctroscopic ellipsometry SAE Society of Automotive Engineers **SAED** selected area electron diffraction

SBD serial bideposition **SCF** supercritical fluid

SEG selective epitaxial growth **SEM** scanning electron microscopy

SERS surface-enhanced Raman spectroscopy

SIMS secondary ion mass spectroscopy

S-K Stranski-Krastanow

SPM scanning probe microscopy

SS stainless steel

SST supersonic transport STEM scanning transmission electron microscopy

STF sculptured thin film

STM scanning tunneling microscopy

SZM structure zone model
TACVD thermally activated CVD
TCO transparent conductive oxide

TCP tricalcium phosphate
TE transverse electric
TEG triethyl gallium

TEM transmission electron microscopy

TEOS tetra ethoxysilane
TEOT tetra ethoxy titanium

TFEL thin film electroluminescent

TIPT tetraisopropyltitanate
TLK Terrace, Ledge, Kink
TM transverse magnetic
TMA trimethyl-aluminum
TMAA trimethyl-amine alane
TMG trimethyl gallium
TOF time-of-flight

TPD thermally programmed desorption

TPO thermoplastic olefin

TRPL time-resolved photoluminescence

UHV ultrahigh vacuum

ULSI ultra large scale integration

UV ultraviolet

VASE variable angle spectroscopic ellipsometry

VLSI very large scale integration VOC volatile organic compound VPD vacuum polymer deposition

VPE vapor phase epitaxy
VR vibrational relaxation
VUV vacuum ultraviolet

WVTR water vapor transmission rate

XANES X-ray absorption near-edge structure XPS X-ray photoelectron spectroscopy

XRD X-ray diffraction XRR X-ray reflectivity

XTEM cross-sectional transmission electron microscopy

YSZ yttria-stabilized zirconia ZDDP zinc dialkyl dithiophosphate